



Product data sheet

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ESDONCAN1LT1G-MS HF 🐼

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SOT-23

Features

- **300** Watts peak pulse power (tp = $8/20\mu s$)
- Bidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- IEC 61000-4-2 ±30kV contact ±30kV air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 8A (8/20µs)

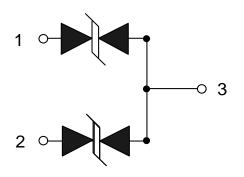
Applications

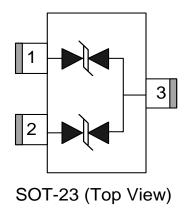
- Dataline
- Automatic Teller Machines
- Net works
- Power line

Mechanical Data

- SOT-23 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

Schematic & PIN Configuration







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Absolute Maximum Rating

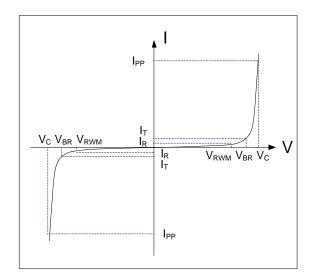
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20 \mu s$)	P _{PP}	300	Watts
Peak Pulse Current ($t_p = 8/20\mu s$) (note1)	I _{pp}	8	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	30 30	kV
Lead Soldering Temperature	T _L	260(10seconds)	°C
Junction Temperature	TJ	-55 to + 125	°C
Storage Temperature	T _{stg}	-55 to + 125	°C

Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V _{RWM}				24.0	v
Reverse Breakdown Voltage	V_{BR}	I _T =1mA	25.5			V
Reverse Leakage Current	I _R	V _{RWM} =24V,Т=25°С		0.1	0.5	μΑ
Peak Pulse Current	I_{PP}	$t_p = 8/20 \mu s$			8	А
Clamping Voltage	V _C	I _{PP} =8A,t _p =8/20µs		35		V
Junction Capacitance	Cj	$V_R = 0V, f = 1MHz$		16		pF

Electrical Parameters (TA = 25 °C unless otherwise noted)

Symbol	Parameter
Ipp	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
IR	Maximum Reverse Leakage Current @ VRWM
VBR	Breakdown Voltage @ IT
Іт	Test Current



Note:. 8/20µs pulse waveform.





Typical Characteristics

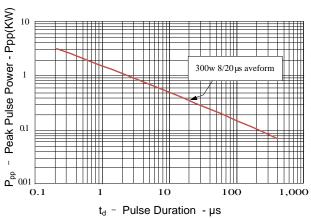


Figure 1: Peak Pulse Power vs. Pulse Time

Figure 2: Power Derating Curve

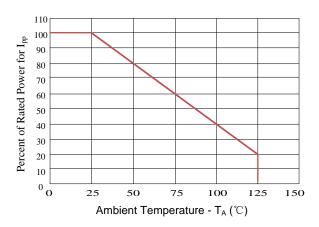
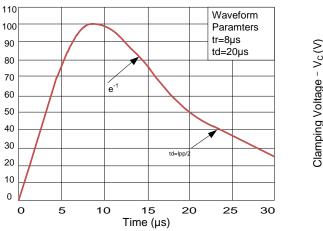


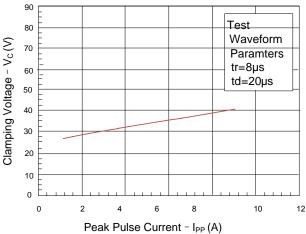
Figure3: Pulse Waveform

dd

Percent

Figure 4: Clamping Voltage vs.lpp



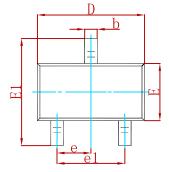


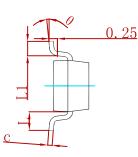


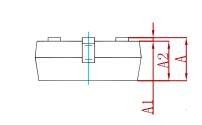
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PACKAGE MECHANICAL DATA

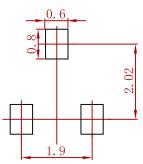






Sympol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950) TYP	0.037	7 TYP
e1	1.800	2.000	0.071	0.079
L	0.550) REF	0.022	2 REF
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters. 2.General tolerance:± 0.05mm.

3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
ESDONCAN1LT1G-MS	SOT-23	3000



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